

PATENT ASSIGNMENT

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Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Chi Kwong Lo</td> <td>02/25/2010</td> </tr> <tr> <td>Lik Hang Wan</td> <td>02/25/2010</td> </tr> <tr> <td>Ming Wa Tam</td> <td>02/25/2010</td> </tr> </tbody> </table>		Name	Execution Date	Chi Kwong Lo	02/25/2010	Lik Hang Wan	02/25/2010	Ming Wa Tam	02/25/2010
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RECEIVING PARTY DATA									
<table border="1"> <tr> <td>Name:</td> <td>UBOTIC INTELLECTUAL PROPERTY COMPANY LIMITED</td> </tr> <tr> <td>Street Address:</td> <td>Flat 18, 15/F, International Trade Centre, 11-19 Sha Tsui Road</td> </tr> <tr> <td>City:</td> <td>Tsuen Wan, New Territories, Hong Kong</td> </tr> <tr> <td>State/Country:</td> <td>CHINA</td> </tr> </table>		Name:	UBOTIC INTELLECTUAL PROPERTY COMPANY LIMITED	Street Address:	Flat 18, 15/F, International Trade Centre, 11-19 Sha Tsui Road	City:	Tsuen Wan, New Territories, Hong Kong	State/Country:	CHINA
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Street Address:	Flat 18, 15/F, International Trade Centre, 11-19 Sha Tsui Road								
City:	Tsuen Wan, New Territories, Hong Kong								
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PROPERTY NUMBERS Total: 1									
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13581270</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13581270				
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CORRESPONDENCE DATA									
<p>Fax Number: 6023647070</p> <p>Phone: 602-364-7000</p> <p>Email: julie.eslick@bryancave.com</p> <p><i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i></p> <p>Correspondent Name: Bryan Cave LLP</p> <p>Address Line 1: Two North Central Avenue, Suite 2200</p> <p>Address Line 2: Julie A. Eslick</p> <p>Address Line 4: Phoenix, ARIZONA 85004</p>									
ATTORNEY DOCKET NUMBER:	0307530								
NAME OF SUBMITTER:	Julie A. Eslick								
<p>Total Attachments: 4</p> <p>source=0307530-US-Assignment#page1.tif</p> <p>source=0307530-US-Assignment#page2.tif</p> <p>source=0307530-US-Assignment#page3.tif</p> <p>source=0307530-US-Assignment#page4.tif</p>									

CH \$40.00 13581270

ASSIGNMENT

In consideration of my agreement with Ubotic Intellectual Property Company Limited, and for other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, Chi Kwong Lo, an individual residing in Tsing Yi, Hong Kong, SAR, China, I, Lik Hang Wan, an individual residing in Fanling, New Territories, Hong Kong, SAR, China, and I, Ming Wa Tam, an individual residing in Sham Tseng, Hong Kong, SAR, China (referred to herein as the "ASSIGNOR"), hereby assign, transfer, set over, convey, and deliver to Ubotic Intellectual Property Company Limited, a Hong Kong company, having a principal place of business located at Flat 18, 15/F., International Trade Centre, 11-19 Sha Tsui Road, Tsuen Wan, New Territories, Hong Kong, its successors and assigns (collectively referred to herein as "ASSIGNEE"), all of my right, title, and interest in, to, and under any and all subject matter of the invention disclosed and/or claimed in the application for Patent Cooperation Treaty (PCT) patent application, titled

**SEMICONDUCTOR PACKAGE FOR MEMS DEVICE AND METHOD OF
MANUFACTURING SAME**

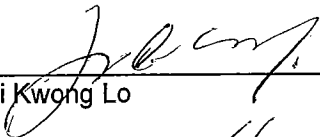
filed on August 24 2012, and assigned Application No. 13/581,270, a copy of which has been provided to me and I have reviewed; in, to and under the said applications and any and all national-stage, utility, design, provisional, continuation, continuation-in-part, continued prosecution, request-for-continued-examination, and divisional applications thereof; in, to, and under, my exclusive right to make and prosecute any and all applications for patents, reissues, reexaminations, renewals, and extensions thereof; in, to, and under any and all patents and convention and treaty rights of all kinds, in China, the United States of America and all other countries throughout the world, for all such subject matter; in, to, and under any and all know-how and/or confidential, proprietary, and/or trade secret information relating to any such subject matter, applications, patents, and/or technology; in, to, and under the right to sue for present, past, and future infringement or misappropriation relating to any such subject matter, applications, patents, and/or technology; in, to, and under the right to enforce any rights and file any causes of action, in law and/or equity, relating to any such subject matter, applications, patents, and/or technology; and in, to, and under the right to all income, royalties, fees, damages, and payments now or hereafter due or payable in respect to any such subject matter, applications, patents, and/or technology. The right, title, and interest is to be held and enjoyed by ASSIGNEE and its successors and assigns as fully and exclusively as it would have been held and enjoyed by ASSIGNOR had this assignment not been made. I request the applicable official having authority to issue patents and/or corresponding rights to issue same on the subject matter of the said invention(s) to ASSIGNEE, its successors and assigns, and, if called upon by ASSIGNEE, its successors, assigns, or legal representatives, I agree to promptly sign any and all documents necessary to secure any and all such patents and/or rights and for issuance of same to ASSIGNEE or its successors and assigns.

I covenant with ASSIGNEE, its successors, assigns, and legal representatives, that the interest and property hereby conveyed is free from all prior assignment, grant, mortgage, license, or other encumbrance.

I grant to ASSIGNEE, its successors, assigns, and legal representatives the power to insert on this assignment any further identification, including the application numbers and filing dates, which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office, and/or any other patent office in any other country throughout the world, for recordation of this document.

I confirm that I have not made any agreement in conflict with this Assignment. I further agree that I will provide information within my knowledge or belief, and do any and all other relevant things that ASSIGNEE, its successors, assigns, or legal representatives deem necessary or desirable and request of me in connection with obtaining and/or maintaining any such patents and/or rights; in connection with any proceeding, controversy, and/or litigation pertaining to any such patents and/or rights; in order to perfect and/or enforce the ownership by ASSIGNEE, its successors and assigns, of the right, title, and interest conveyed by this Assignment; and/or in connection with this Assignment, without payment of consideration to me beyond that called for in my written agreement with ASSIGNEE on the understanding, however, that ASSIGNEE will bear all reasonable expenses actually incurred for or in connection with such matters. This Assignment and the obligations assumed by me shall be binding on my heirs and personal representatives.

Date: 25 Feb 2010



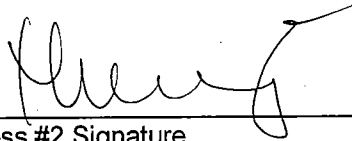
Chi Kwong Lo



Witness #1 Signature

CHAN YEE PING

Witness #1 Printed Name




Witness #2 Signature


WANG MUMMA

Witness #2 Printed Name

Date: 25 Feb 2010




Lik Hang Wan



Witness #1 Signature

CHAN YEE PING

Witness #1 Printed Name

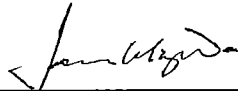


Witness #2 Signature

WANG HUI MIN

Witness #2 Printed Name

Date: 25 Feb 2010



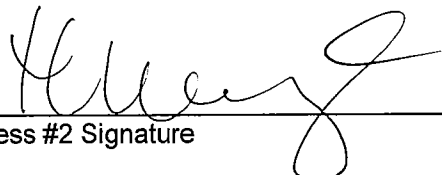
Ming Wa Tam



Witness #1 Signature

CHAN YEE PING

Witness #1 Printed Name



Witness #2 Signature

WANG HUI MIN

Witness #2 Printed Name